

11-30-2007

U.S. PTO

11/984623

11/20/2007

Form PTO-1595 (Rev. 0
OMB No. 0651-0027 (ex)U.S. DEPARTMENT OF COMMERCE
United States Patent and Trademark Office

103465169

OVER SHEET

PATENT ONLY

11-20-07

To the Director of the U.S. Patent and Trademark Office: Please record the attached documents or the new address(es) below.

1. Name of conveying party(ies):

Hong-Wei Lee

Additional name(s) of conveying party(ies) attached? ☐ Yes ☒ No

2. Name and address of receiving party(ies)

Name: Micron Technology, Inc.

Internal Address: _____

Street Address: _____

8000 S. Federal Way

City: BoiseState: IdahoCountry: United States Zip: 83706-9632Additional name(s) & address(es) attached? ☐ Yes ☒ No

3. Nature of conveyance/Execution Date(s):

Execution Date(s): November 13, 2007☒ Assignment ☐ Merger ☐ Change of Name☐ Security Agreement ☐ Joint Research Agreement☐ Government Interest Assignment☐ Executive Order 9424, Confirmatory License☐ Other _____

4. Application or patent number(s):

A. Patent Application No.(s)

☒ This document is being filed together with a new application.

B. Patent No.(s)

Additional numbers attached? ☐ Yes ☒ No

5. Name and address to whom correspondence concerning document should be mailed:

Name: Thomas J. D'Amico
DICKSTEIN SHAPIRO LLPInternal Address: Atty. Dkt.: M4065.1451/P1451Street Address: 1825 Eye Street, NWCity: WashingtonState: DC Zip: 20006-5403Phone Number: (202) 420-2232Fax Number: (202) 420-2201Email Address: DAmicoT@dicksteinshapiro.com

6. Total number of applications and patents involved:

1

7. Total fee (37 CFR 1.21(h) & 3.41) \$ 40.00☒ Authorized to be charged by credit card☒ Authorized to be charged to deposit account☐ Enclosed☐ None required (government interest not affecting title)

8. Payment Information

a. Credit Card Last 4 Numbers 1002Expiration Date 01/11b. Deposit Account Number 04-1073Authorized User Name Dickstein Shapiro LLP

9. Signature:

Signature

November 20, 2007

Date

Thomas J. D'Amico - 28,371

Name of Person Signing

Total number of pages including cover sheet, attachments, and documents:

3

11/21/2007 RMEBRAHT 00000053 11984623

31 FC:8021

40.00 OP

PATENT
REEL: 020184 FRAME: 0744

ASSIGNMENT AND AGREEMENT

For value received, I, Hong-Wei Lee, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled ANTI-RESONANT REFLECTING OPTICAL WAVEGUIDE FOR IMAGER LIGHT PIPE, described in an application for Letters Patent of the United States, executed by me on even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this Assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

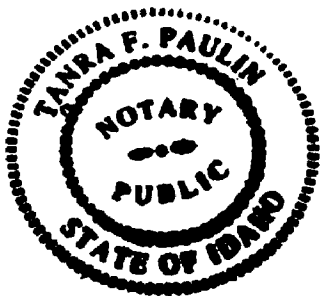
Hong-Wei Lee

Date: Nov. 13, 2007

United States of America)
State of Idaho) ss.:
County of Ada)

On this 13th day of November, 2007, before me personally came Hong-Wei Lee, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.

Notary Public



ASSIGNMENT AND AGREEMENT

For value received, I, Hong-Wei Lee, hereby sell, assign and transfer to Micron Technology, Inc., a corporation of the State of Delaware, having an office at 8000 S. Federal Way, Boise, Idaho 83706-9632, U.S.A., and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to an invention entitled ANTI-RESONANT REFLECTING OPTICAL WAVEGUIDE FOR IMAGER LIGHT PIPE, described in an application for Letters Patent of the United States, executed by me on even date herewith, and all the rights and privileges in said application and under any and all Letters Patent that may be granted in the United States for said inventions; and I also concurrently hereby sell, assign and transfer to Micron Technology, Inc. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Micron Technology, Inc. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this Assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Micron Technology, Inc. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Micron Technology, Inc. in the United States and in all countries foreign to the United States, or to such nominees as Micron Technology, Inc. may designate.

I agree that, when requested, I shall, without charge to Micron Technology, Inc. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.



Hong-Wei Lee

Date: Nov. 13, 2007

United States of America)
State of Idaho) ss.:
County of Ada)

On this 13th day of November, 2007, before me personally came Hong-Wei Lee, to me known to be the individual described in and who executed the foregoing instrument, and acknowledged execution of the same.



Notary Public

